2

PATTERNED MAGNETIC RECORDING MEDIA WITH DISCRETE MAGNETIC REGIONS SEPARATED BY REGIONS OF ANTIFERROMAGNETICALLY COUPLED FILMS

TECHNICAL FIELD

This invention relates generally to magnetic recording media, and more particularly to patterned magnetic recording disks with discrete magnetic regions.

BACKGROUND OF THE INVENTION

Conventional magnetic recording media, such as the magnetic recording disks in hard disk drives, typically use a granular ferromagnetic layer, such as a sputter-deposited cobalt-platinum (CoPt) alloy, as the recording medium. Each magnetized domain in the magnetic layer is comprised of many small magnetic grains. The transitions between magnetized domains represent the "bits" of the recorded data. IBM's U.S. Pat. Nos. 4,789,598 and 5,523,173 describe this type of conventional rigid magnetic recording disk.

The challenge of producing continuous granular films as magnetic media will grow with the trend toward higher areal storage densities. Reducing the size of the magnetic bits while maintaining a satisfactory signal-to-noise ratio, for example, requires decreasing the size of the grains. Unfortunately, significantly reducing the size of weakly magnetically coupled magnetic grains will make their magnetization unstable at normal operating temperatures. To postpone the arrival of this fundamental "superparamagnetic" limit and to avert other difficulties associated with extending continuous granular media, there has been renewed interest in patterned magnetic media.

With patterned media, the continuous granular magnetic 35 film that covers the disk substrate is replaced by an array of spatially separated discrete magnetic regions or islands, each of which serves as a single magnetic bit. The primary approach for producing patterned media has been the use of lithographic processes to selectively deposit or remove magnetic material from a magnetic layer on the substrate so that magnetic regions are isolated from one another and surrounded by areas of nonmagnetic material. Examples of patterned magnetic media made with these types of lithographic processes are described in U.S. Pat. Nos. 5,587,223; 45 5,768,075 and 5,820,769.

From a manufacturing perspective, an undesirable aspect of the process for patterning media that requires the deposition or removal of material is that it requires potentially disruptive processing with the magnetic media in place. 50 Processes required for the effective removal of resists and for the reliable lift-off of fine metal features over large areas can damage the material left behind and therefore lower production yields. Also, these processes must leave a surface that is clean enough so that the magnetic read/write head supported on the air-bearing slider of the disk drive can fly over the disk surface at very low flying heights, typically below 30 nanometers (nm).

An ion-irradiation patterning technique that avoids the selective deposition or removal of magnetic material, but 60 uses a special type of perpendicular magnetic recording media, is described by Chappert et al, in "Planar patterned magnetic media obtained by ion irradiation", Science, Vol. 280, Jun. 19, 1998, pp. 1919–1922. In this technique Pt—Co—Pt multilayer sandwiches which exhibit perpendicular magnetocrystalline anisotropy are irradiated with ions through a lithographically patterned mask. The ions mix

the Co and Pt atoms at the layer interfaces and reorient the easy axis of magnetization to be in-plane so that the irradiated regions no longer have perpendicular magnetocrystal-line anisotropy.

IBM's application Ser. No. 09/350,803, filed Jul. 9, 1999, now U.S. Pat. No. 6,331,364, describes an ion-irradiated patterned disk that uses a continuous magnetic film of a chemically-ordered Co (or Fe) and Pt (or Pd) alloy with a tetragonal crystalline structure. The ions cause disordering in the film and produce regions in the film that are low coercivity or magnetically "soft" and have no magnetocrystalline anisotropy.

A potential disadvantage of the Chappert et al. and IBM ion-irradiated patterned disks is that the regions separating the discrete magnetic regions from one another are not completely nonmagnetic, but still have some magnetic properties. Thus the magnetoresistive read head in the disk drive will detect noise and/or some type of signal from these regions. In addition, these ion irradiation techniques require the use of a mask that is difficult to fabricate because the holes in the mask are used to generate corresponding nonmagnetic regions on the disk, whereas it is desirable to use a mask that has the same hole pattern as the resulting magnetic bits on the disk.

What is needed is a patterned magnetic recording disk that has discrete magnetic regions separated by completely non-magnetic regions so that only the magnetic regions contribute to the read signal, and that is made by a patterning technique where the mask pattern of holes matches the pattern of discrete magnetic regions of the disk.

SUMMARY OF THE INVENTION

The present invention is a magnetic recording disk that is patterned into discrete magnetic and nonmagnetic regions with the magnetic regions serving as the magnetic recording data bits. The magnetic recording layer comprises two ferromagnetic films separated by a nonferromagnetic spacer film. The spacer film material composition and thickness is selected such that the first and second ferromagnetic films are antiferromagnetically coupled across the spacer film. After this magnetic recording layer has been formed on the disk substrate, ions are irradiated onto it through a patterned mask. The ions disrupt the spacer film and thereby destroy the antiferromagnetic coupling between the two ferromagnetic films. As a result, in the regions of the magnetic recording layer that are ion-irradiated the first and second ferromagnetic films are essentially ferromagnetically coupled so that the magnetic moments from the ferromagnetic films are parallel and produce a magnetic moment that is essentially the sum of the moments from the two films. In the non-irradiated regions of the magnetic recording layer, the first and second ferromagnetic films remain antiferromagnetically coupled so that their magnetic moments are oriented antiparallel. The composition and thicknesses of the first and second ferromagnetic films are selected such that essentially no magnetic field is detectable at a predetermined distance above the magnetic recording layer corresponding to the height that the magnetic recording head would be

For a fuller understanding of the nature and advantages of the present invention, reference should be made to the following detailed description taken together with the accompanying figures.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a schematic sectional view of the magnetic recording disk showing the antiferromagnetically (AF) coupled layer prior to patterning.

3

FIG. 2 is a schematic illustration of the process for patterning the AF-coupled layer by ion irradiation through a stencil mask.

FIG. 3 is a magnetic force microscopy (MFM) image of the patterned AF-coupled layer showing discrete oblong-shaped magnetic regions.

FIGS. 4A-4B are schematic views of the disk structure of the present invention showing different magnetic bit states with their corresponding signal profiles.

DETAILED DESCRIPTION OF THE INVENTION

Preferred Embodiments

The magnetic recording medium of the present invention is made by first forming a continuous (non-patterned) magnetic layer of two or more ferromagnetic films that are exchange-coupled antiferromagnetically (AF) to their neighboring ferromagnetic films by one or more nonferromagnetic spacer films. FIG. 1 illustrates the cross sectional layer structure of the disk 10 with the AF-coupled magnetic layer 20 prior to patterning.

The disk substrate 11 may be made or any suitable material, such as glass, SiC/Si, ceramic, quartz, or an AlMg alloy base with a NiP surface coating. The seed layer 12 is an optional layer that may be used to improve the growth of 25 the underlayer 13. The seed layer 12 is most commonly used when the substrate 11 is nonmetallic, such as glass. The seed layer 12 has a thickness in the range of approximately 0.5 to 5 nm and is one of the materials, such as Ta, CrTi or NiAl, which are known in the prior art to be useful as seed 30 materials for promoting the growth of subsequently deposited layers in certain preferred crystalline orientations. The underlayer 13 is deposited onto the seed layer, if present, or otherwise directly onto the substrate 11, and is a nonmagnetic material such as chromium or a chromium alloy, such 35 as CrV or CrTi. The underlayer 13 has a thickness in the range of 5 to 1000 nm with a typical value being approximately 50 nm.

The AF-coupled magnetic layer 20 is made up of two ferromagnetic films 22, 24 separated by a nonferromagnetic 40 spacer film 26. The nonferromagnetic spacer film 26 thickness and composition are chosen so that the magnetic moments 32, 34 of adjacent films 22, 24, respectively, are AF-coupled through the nonferromagnetic spacer film 26 and are antiparallel in zero applied field. In the preferred 45 embodiment the two AF-coupled films 22, 24 of layer 20 have magnetic moments that are oriented antiparallel with the lower film 24 having a larger moment so that the net magnetic field from the AF-coupled layer 20 is close to zero at the recording head located above the disk. Each of the 50 ferromagnetic films 22, 24 is preferably a Co alloy, such as a CoPtCrB alloy with 4 to 20 atomic percent (at. %) platinum, 10 to 23 at. % chromium and 2 to 20 at. % boron, and the nonferromagnetic spacer film 26 is preferably ruthenium (Ru).

Before the deposition of the first ferromagnetic film 24 of the AF-coupled magnetic layer 20, a very thin (typically 1 to 5 nm) Co alloy onset or nucleation layer 14 is typically deposited on the underlayer 13. The nucleation layer 14 has a composition selected to enhance the growth of the hexagonal close-packed (HCP) Co alloy of film 24 so that its C-axis is oriented in the plane of the layer. The nucleation layer 14 may be a CoCr alloy with a Cr composition selected so as to make the layer 14 nonferromagnetic or very slightly ferromagnetic. Alternatively, the nucleation layer 14 may be a ferromagnetic Co alloy, in which case the nucleation layer 14 will affect the magnetic properties of the film 24. If the

4

film 24 is CoPtCrB, then the nucleation layer 14 may be CoPtCr or CoPtCrB with B less than 6 at. %. All of the layers described above from the seed layer 12 to the top ferromagnetic film 22 can be sputtered in a continuous process in 5 either an in-line sputtering system or a single disk system, such as commercially available single disk systems with multiple sputtering target capacity. The sputter deposition of each of the layers can be accomplished using standard targets and techniques known to those in the field with the 10 modifications described above.

The AF coupling of ferromagnetic films via a nonferromagnetic transition metal spacer film, like the structure of layer 20 in FIG. 1, has been extensively studied and described in the literature. In general, the exchange coupling oscillates from ferromagnetic to antiferromagnetic with increasing spacer film thickness. This oscillatory coupling relationship for selected material combinations is described by Parkin et al. in "Oscillations in Exchange Coupling and Magnetoresistance in Metallic Superlattice Structures: Co/Ru, Co/Cr and Fe/Cr", Phys. Rev. Lett., Vol. 64, p. 2034 (1990). The material combinations include ferromagnetic films made of Co, Fe, Ni, and their alloys, such as Ni-Fe, Ni-Co, and Fe-Co, and nonferromagnetic spacer films such as Ru, chromium (Cr), rhodium (Rh), iridium (Ir), copper (Cu), and their alloys. For each such material combination, the oscillatory exchange coupling relationship has to be determined, if not already known, so that the thickness of the nonferromagnetic spacer film is selected to assure antiferromagnetic coupling between the two ferromagnetic films. The period of oscillation depends on the nonferromagnetic spacer material, but the strength and phase of the oscillatory coupling also depends on the ferromagnetic material and interfacial quality. The oscillatory antiferromagnetic coupling of ferromagnetic films has been used in spin-valve type giant magnetoresistance (GMR) recording heads to design continuous magnetized antiferromagnetically coupled films whose magnetic moments are rigidly coupled together antiparallel during operation of the head. These type of spin-valve structures are described, for example, in IBM U.S. Pat. Nos. 5,408,377 and 5,465,185. The '185 patent describes a structure used in many commercially available spin-valve GMR heads, namely a laminated antiparallel pinned ferromagnetic layer having ferromagnetic films whose moments are rigidly coupled together and remain stationary during operation of the head. This type of magnetic structure of two ferromagnetic films antiferromagnetically coupled across a very thin nonferromagnetic spacer film, such as used in spin-valve heads and show in the AF-coupled magnetic layer 20 of FIG. 1, is also called a "synthetic antiferromagnet". In the case where the structure has no net magnetic moment because the moments from the individual ferromagnetic films cancel, the structure can be called a "compensated" synthetic antiferromagnet.

For this AF-coupled structure of layer 20 the orientations of the magnetic moments 32, 34 of adjacent films 22, 24, respectively, are aligned antiparallel and thus add destructively. The arrows 32, 34 represent the moment orientations of individual magnetic domains that are directly above and below one another across the AF coupling film 26. In the absence of an applied magnetic field, when the bottom ferromagnetic film 24 is deposited onto the nucleating layer 14, it will have a granular structure with multiple adjacent grains being coupled together to form individual magnetic domains. In the absence of an applied magnetic field the moments of these domains in film 24 will be essentially randomly oriented. The spacer film or AF-coupling film 26 is then deposited to the correct thickness directly on ferro-

5

magnetic film 24. Next, the second or top ferromagnetic film 22 is deposited directly on the AF coupling film 26. As the grains of ferromagnetic film 22 grow they will form magnetic domains with moment orientations that are antiparallel to the moment orientations of ferromagnetic film 24 that are 5 directly across the AF coupling film 26.

The type of ferromagnetic material and the thickness values t1, t2 of the ferromagnetic films 22, 24 are chosen so that the field strength above the disk at the height where the recording head is located is essentially equal for the two 10 films. The Mrt for the layer 20 is given by Mr₁t₁-Mr₂t₂. In the preferred embodiment, Mr_1t_1 should be less than Mr_2t_2 because film 22 is closer to the head. This may be accomplished by using the same ferromagnetic materials in the two films 22, 24 and adjusting t, and t₂. If different ferromag- 15 netic material compositions are used in the two films 22, 24 so that the magnetization (the magnetic moment per unit volume of material) of the two ferromagnetic films is made different, then the thicknesses are adjusted accordingly. In an alternative embodiment, the two films 22, 24 can be with 20 Mr,t,=Mr,t, so that the layer 20 has substantially zero net magnetic moment. In that case there would be some small field detected at the head because the upper film 22 is closer to the head.

While FIG. 1 is shown for a AF-coupled magnetic layer 25 20 with a two-film structure and a single spacer film, the invention is extendible to structures with multiple spacer films and multiple ferromagnetic films.

The nonferromagnetic spacer film 26 in FIG. 1 is a 0.6 nm Ru film. The Ru spacer film thickness was chosen to be at 30 the first antiferromagnetic peak in the oscillatory coupling relationship. It may also be desirable for each of the CoPtCrB ferromagnetic films 22, 24 to include an interface film consisting essentially of 0.5 nm of Co at the interface with the Ru spacer film 26. These ultra-thin Co films increase the 35 interfacial moment between the ferromagnetic films and the spacer film, resulting in enhanced antiferromagnetic coupling. However, antiferromagnetic exchange coupling will occur without incorporating the Co interface films in the CoPtCrB ferromagnetic films 22, 24.

After the AF-coupled magnetic layer 20 has been formed it is patterned to form discrete isolated magnetic regions separated from one another by "nonmagnetic" regions that produce essentially no magnetic field at the head. The discrete magnetic regions are sized to function as discrete 45 magnetic domains or bits. This patterning is performed without the need for selective deposition or removal of the magnetic material. Regions of the AF-coupled layer 20 are transformed by ion irradiation from two ferromagnetic films AF-coupled across the Ru spacer film 26 to two ferromagnetic films that are ferromagnetically coupled so that their magnetic moments are parallel.

In the preferred patterning method, a stencil mask is irradiated with a dose of nitrogen ions (N+) and the ions are selectively transmitted through the holes in the mask. The 55 ions pass through the holes in the mask and impact the AF-coupled layer 20 in selected regions corresponding to the pattern of holes in the mask. The ions disrupt the interface between the Ru spacer film 26 and the ferromagnetic films 22, 24, and destroy the AF-coupling of the ferromagnetic films 22, 24. This occurs essentially without disturbing the magnetic properties of the ferromagnetic films 22, 24 and creates regions where the two ferromagnetic films are coupled together ferromagnetically with their magnetic moments oriented parallel. The regions not impacted by the 65 N+ ions remain AF-coupled and thus have essentially no net magnetic moment as measured at the head. As a result the

6

magnetic regions are separated from one another by "nonmagnetic" regions that have no magnetization. Thus the pattern of holes in the mask corresponds to the pattern of magnetic bit regions on the disk.

FIG. 2 illustrates the patterning process schematically. The layer 20 remains AF-coupled across the spacer film (represented by cross-hatching of film 26) in the regions 52, 54 not aligned with a hole 56 in the silicon stencil mask 60. In the region 55 of layer 20 that is aligned with a hole 56 in mask 60, disordering of the interface between the Ru spacer film and the ferromagnetic films 22, 24 has occurred (as represented by the dotted area of film 26), and the magnetic moments of the two films 22, 24 become ferromagnetically coupled.

The stencil mask 60 is a non-contact mask that comprises a wafer, such as silicon, with holes etched through it. The ions, depicted by arrows 62, are transmitted through the holes in the wafer. The silicon stencil mask was fabricated from a commercial silicon-on-insulator (SOI) wafer with a 10 μ m-thick top side silicon layer, 0.5 μ m of SOI oxide, and a 500 µm-thick silicon carrier substrate. The stencil holes were first patterned by optical lithography and then transferred into the 10 µm-thick Si layer by SF₆-based, high aspect ratio reactive ion etching (RIE) with the SOI oxide serving as a reliable etch stop. Windows were then etched from the back side through the carrier substrate, using a similar RIE process, and the remaining SOI oxide was removed with a wet HF etch. The resulting silicon membrane is approximately 10 µm thick and covers an area of 1×1 mm. The holes in the membrane are nominally 1 μ m in diameter, although somewhat irregular in shape, and are replicated throughout its area with a regular spacing of 1 to 10 μ m. In making the patterned media two such stencil masks can be aligned with their holes overlapping to create holes with effective diameters in the range of 100 nm. However, it is possible to fabricate a single stencil mask in this manner, with much smaller holes in the sub-100 nm range, to produce patterned media with the desired areal density. A detailed description of the use of stencil masks for ion-beam patterning is described by B. D. Terris et al., "Ion-beam patterning of magnetic films using stencil masks", Appl. Phys. Lett., Vol. 75, No. 3, Jul. 19, 1999, which is incorporated herein by reference. In the preferred embodiment the mask has holes formed in a pattern to form a magnetic recording disk with concentric circular tracks, with each track having discrete magnetic regions spaced along it to serve as the individually recordable magnetic bits.

While nitrogen ions were used, other ion species that may be used include ions of He, Ar, Ne, Kr and Xe. The voltage and dosage of the ion irradiation required to achieve the desired disruption of the interface between the Ru spacer film 26 and the ferromagnetic films 22, 24 can be determined experimentally.

The preferred method for patterning the media with ion irradiation is by a non-contact mask, such as the silicon stencil mask described above. However, it is also possible to use conventional lithography, where a photoresist is formed on the AF-coupled layer and then patterned to expose openings aligned with portions of the layer intended to become the magnetic bit regions that are separated or isolated from the "nonmagnetic" regions.

After the AF-coupled layer has been patterned, a conventional protective overcoat (not shown in FIG. 1) can be formed over it to complete the fabrication of the patterned magnetic disk. The protective overcoat may be a typical overcoat of sputter deposited essentially amorphous carbon optionally doped with hydrogen and/or nitrogen. The overcoat is typically less than 15 nm thick.